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## Second Thoughts on MQE Calculations for the SHMS Dipole Conductor

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### **1. Introduction**

Looking at the gaps in soldering shown on the tomography and cross section pictures of the conductor, I am feeling increasingly uncomfortable about the validity of my earlier MQE calculations (Report SJ7). The model I use is a very simple one dimensional one in which I assume that the superconductor and copper are intimately mixed, in perfect contact and sharing the same temperature and electric potential. It takes no account of any fine structure, so how to calculate the situation shown in Fig 1?



Fig 1: from 'Tomography on JLAB's conductor 23 Sept 12.

The best I can offer is to calculate a model where cable plus solder plus insulation is detached from copper, as sketched in Fig 2.



Fig 2: Calculation model with cable detached from copper.

With this model, I find a big reduction in MQE. Using exactly the same data as in Report SJD7, with RRR = 100, the MQE falls from 28mJ with copper attached to 1.9mJ with the attachment broken. Details of the calculation are presented in the appendix.

The question then arises as to how large the area of void can be before things start to go wrong. Fig 3, taken from the appendix shows the temperature profile along the conductor at various times after the imposition of an energy spike.



Fig 3: Temperature profiles along the conductor at different times after the initial energy spike (x axis in metres, y axis  $2^{nd}$  subscript in units of 10µsec, ie  $U_{nx,5000}$  is at 50msec).

It may be seen that everything happens within a half width of less than 1cm; this width is often called the minimum propagating zone. Thus it would appear that, if the cable is detached from the copper over a length of more than 2cm, it's response to an energy spike will be more like a separate cable than an integrated conductor.

## **Concluding Remarks**

These calculations are crude and approximate, but they are the best we have in trying to predict how stable the conductor will be against training and degraded performance in the magnet. The observed voids in solder bonding do appear to be larger than the predicted minimum propagating zone, so it seems likely that the MQE of those parts of the conductor will be nearer 1.9mJ than the previously calculated 28mJ. This can only mean that the magnet will suffer from much more training and may not achieve it's design field. If we add to this lack of stability the possibility of increased conductor motion coming from spongey mechanical properties, we have a double whammey.

# Appendix 1: Details of the Mathcad MQE Calculation

<u>JLab SHMS Dipole MQE</u> series B cable not in contact with copper revisited 18 Oct 12

Revised 12 May 10 because new Mathcad will not accept fractional exponents of variables with units. Make dimensionless before raising to exponent.

Use generation term with resistive transition from MPZSING1 and NORMPROP6, eqs from TIME1W1 SI Uni

$$C(\theta) \cdot \frac{d\theta}{dt} = \frac{d}{dx} \cdot \left( k(\theta) \cdot \frac{d\theta}{dx} \right) + G(\theta) + Q(x,t) - H(\theta) \cdot \frac{P}{A} \qquad C(\theta) \cdot \frac{d\theta}{dt} = k(\theta) \cdot \frac{d^2 \cdot \theta}{dx^2} + \frac{d \cdot k(\theta)}{dx} \cdot \frac{d\theta}{dx} + G(\theta) + Q(x,t) - H(\theta) \cdot \frac{P}{A}$$
  
solve this one 
$$C(\theta) \cdot \frac{d\theta}{dt} = k(\theta) \cdot \frac{d^2 \cdot \theta}{dx^2} + \frac{d \cdot k(\theta)}{d\theta} \cdot \left( \frac{d\theta}{dx} \right)^2 + G(\theta) + Q(x,t) - H(\theta) \cdot \frac{P}{A}$$

where A is overall cross section, k is averaged over A, C and G are per unit volume and H is per unit area





#### 2) Conductor Geometry unit cell includes wire solder and some insulation

channel width  $w_{ch} := 0.486n = 12.344 \text{ mm}$ channel thickness  $t_{ch1} := 0.043in = 1.092 \text{ mm}$   $t_{ch2} := 0.051in = 1.295 \text{ mm}$   $t_{chm} := 0.5 \cdot (t_{ch1} + t_{ch2}) = 1.194 \text{ mm}$ wire dia  $d_w := 0.65 \text{ mm}$  number of wires  $N_w := 36$  mat := 1.6 cable size from Paul Berindza email 3 Dec  $w_{cab} := 11.68 \text{ mm}$  thicks  $t_{cab} := \frac{(1.271 \text{ mm} + 1.0530 \text{ mm})}{2} = 1.162 \text{ mm}$  thickness  $t_{ch} := t_{cab}$ wire area  $A_w := N_w \cdot \frac{\pi}{4} \cdot d_w^2 = 11.946 \text{ mm}^2$   $\lambda_{cab} := \frac{A_w}{w_{cab} \cdot t_{cab}} = 0.88$  channel occupie  $\mathbf{A}_{ch} := w_{ch} \cdot t_{ch} = 14.344 \text{ mm}^2$ wire copper area  $A_{wcu} := A_w \cdot \frac{\text{mat}}{1 + \text{mat}} = 7.351 \text{ mm}^2$  wire NbTi area  $A_{nt} := A_w \cdot \frac{1}{1 + \text{mat}} = 4.595 \text{ mm}^2$ solder area  $A_{so} := A_{ch} - A_w = 2.398 \text{ mm}^2$ insulation thickness  $t_i := 0.28 \text{ mm}$  insulation width  $w_i := w_{ch}$  insulation area  $A_i := t_i \cdot w_i$ width unit cell  $w_u := w_{ch}$  thickness  $t_u := t_{cab} + t_i = 1.442 \text{ mm}$  unit cell area  $A_u := w_u \cdot t_u = 17.801 \text{ mm}^2$ copper area  $A_{cu} := A_{wcu} = 7.351 \text{ mm}^2$  $\lambda_{so} := \frac{A_{so}}{1 + 1000} = 0.135$   $\lambda_i := \frac{A_i}{A_u} = 0.194$ 

$$\lambda_{cu} := \frac{1}{A_u} = 0.413 \qquad \lambda_{nt} := \frac{1}{A_u} = 0.258 \qquad A_u \qquad A_u$$

$$check \quad \lambda_{cu} + \lambda_{nt} + \lambda_{so} + \lambda_i = 1 \qquad A_{con} := A_{ch} \qquad J_{op} := \frac{I_{op}}{A_{con}} = 238.382 \text{ A} \cdot \text{mm}^{-2}$$

e) Unit cell take only half the epoxy to allow for heat diffusion  $\lambda_{id} := \lambda_i \cdot 0.5$  $C_{con}(\theta) := \lambda_{nt} \cdot C_{nt}(\theta, B_p) + \lambda_{cu} \cdot C_{cu}(\theta) + \lambda_{so} \cdot C_{so}(\theta) + \lambda_{id} \cdot C_e(\theta)$   $C_{con}(6K) = 6.035 \times 10^3 K^{-1} \cdot m^{-3} \cdot J$ 



6) Generation using resistive transition model from RESTRAN3.mcd 
$$J_{op} = 238.382 \text{ A} \cdot \text{mm}^{-2}$$
  
definep, G and Jt over whole conductor section, break at Js  
define the over metal area  $\rho_{em} := \rho_{cB} \cdot \frac{(A_{con})}{A_{cu}} = 7.528 \times 10^{-10} \cdot \text{ohmm}$   $J_{cBp} := \frac{I_c}{A_{nt}} = 2.274 \times 10^3 \cdot \text{A} \cdot \text{mm}^{-2}$   
 $J_s = J_o(\theta) \cdot \left[\frac{\rho_{ecu}}{\rho_o \cdot (n+1)}\right]^{\frac{1}{n}}$   $J_0 := J_{cBp} \cdot \frac{A_{nt}}{A_{con}}$   $\rho_{o} := 10^{-14} \cdot \text{ohmm}$   $\frac{n}{m} := 30$   
 $J_{o1}(\theta) := J_0 \cdot \frac{\theta_c(B_p) - \theta}{(\theta_c(B_p) - \theta_o)}$   $J_o(\theta) := if \left(\theta < \theta_c(B_p), J_{o1}(\theta), 0.1 \cdot \text{amp} \cdot \text{m}^{-2}\right)$   $J_s(\theta) := J_o(\theta) \cdot \left[\frac{\rho_{em}}{\rho_o \cdot (n+1)}\right]^{\frac{1}{n}}$   
above J.s below Js  $G1 = V \cdot J_t = J_{op}^{-2} \cdot \rho_o \cdot \left(\frac{J_t}{J_o}\right)^n$   $G1(\theta) := J_{op}^{-2} \cdot \rho_o \cdot \left(\frac{J_{op}}{J_o(\theta)}\right)^n$   
 $G2 = J_t \cdot V = J_{op} \cdot J_o \cdot \rho_o \cdot \left[\frac{\rho_{ecu}}{\rho_o \cdot (n+1)}\right]^{\frac{n+1}{n}} + J_{op} \cdot (J_t - J_s) \cdot \rho_{ecu}$   $G2(\theta) := J_{op} \cdot J_o(\theta) \cdot \rho_o \cdot \left[\frac{\rho_{em}}{\rho_o \cdot (n+1)}\right]^{\frac{n+1}{n}} + J_{op} \cdot (J_{op} - J_s(\theta)) \cdot \rho_{em}$ 

Global G function 
$$G_t(\theta) := if(J_{op} < J_s(\theta), G1(\theta), G2(\theta))$$

 $\mathbf{G}(\theta) := \mathrm{if}\left(\theta < \theta_{c}(\mathbf{B}_{p}), \mathbf{G}_{t}(\theta), \mathbf{G}_{t}(\theta_{c}(\mathbf{B}_{p}))\right)$ 

### inear G for comparison

$$\begin{aligned} G_{c} &:= J_{op}^{2} \cdot \rho_{em} \qquad G_{c} = 4.278 \times 10^{7} \text{m}^{-3} \cdot \text{watt} \qquad \theta_{g} := \theta_{c} (B_{p}) - (\theta_{c} (B_{p}) - \theta_{o}) \cdot \frac{I_{op}}{J_{c Bp} \cdot A_{nt}} \qquad \theta_{g} = 6.233 \text{K} \\ R(\theta) &:= if \Biggl[ \theta < \theta_{g}, 0, \frac{\theta - \theta_{g}}{(\theta_{c} (B_{p}) - \theta_{g})} \Biggr] \qquad Rf(\theta) := if \Bigl( \theta < \theta_{c} (B_{p}), R(\theta), 1 \Bigr) \qquad G_{L}(\theta) := G_{c} \cdot Rf(\theta) \end{aligned}$$

### 7) Heat Transfer through insulation

$$Q' \cdot x = A \cdot \int_{\Theta_0} B_i \cdot \theta^n d\theta \qquad Q' = \frac{A}{x} \cdot \frac{B_i}{n+1} \cdot \left(\theta^{n+1} - \theta_0^{n+1}\right)$$

$$h_{i}(\theta) = \frac{1}{x} \cdot \frac{B_{i}}{n_{i}+1} \cdot \left\lfloor \left( \theta \cdot K^{-1} \right)^{n_{i}} \cdot \theta - \left( \theta_{o} \cdot K^{-1} \right)^{n_{i}} \cdot \theta_{o} \right\rfloor$$

per unit length let heat transfer = Hi

insulation wrap thickness  $t_i = 0.28 \cdot mm$ 

 $\label{eq:product} \text{interturn perimeter} \qquad P_{i1} := w_{ch} = 12.344 \text{\cdot} mm$ 

cooling per unit length

$$\begin{split} H_{i}(\theta) &= \left(\sum_{\bullet} \frac{P}{x}\right) \cdot \frac{B_{i}}{n_{i}+1} \cdot \left[ \left(\theta \cdot K^{-1}\right)^{n_{i}} \cdot \theta - \left(\theta_{o} \cdot K^{-1}\right)^{n_{i}} \cdot \theta_{o} \right] \\ H_{ip}(\theta) &:= \left(\frac{P_{i1}}{t_{i}}\right) \cdot \frac{B_{i}}{n_{i}+1} \cdot \left[ \left(\theta \cdot K^{-1}\right)^{n_{i}} \cdot \theta - \left(\theta_{o} \cdot K^{-1}\right)^{n_{i}} \cdot \theta_{o} \right] \end{split}$$

avoid negative cooling

$$H_i(\theta) := if(\theta < \theta_o, 10^{-9} \cdot watt \cdot m^{-1}, H_i)$$





rough check

$$H_{i2}(\theta) := k_i \!\! \left[ \frac{\left( \theta + \theta_o \right)}{2} \right] \! \cdot \! \left( \theta - \theta_o \right) \! \cdot \! \left( \frac{P_{i1}}{t_i} \right)$$

$$H_{i2}(6K) = 6.02m^{-1}$$
·watt

spot value check







$$\begin{aligned} \mathbf{y} \ \mathbf{Parameters for solution} & \text{define x interval } \mathbf{dx} := 1 \text{ mm}} & \text{time interval } \mathbf{dx} := 10 \cdot 10^{-6} \text{ sec} \end{aligned}$$

$$\begin{aligned} & \text{ff MPZ} \\ \text{for MPZ} \\ \text{fadius} \\ \theta_{ab} := \frac{\theta_c(B_0) + \theta_g}{2} & X_g := \sqrt{\frac{2^{12} k_{con}(\theta_{ab}) + (\theta_c(B_0) - \theta_g)}{G_c}} & X_g = 2.686 \text{ mm}} & \frac{dx}{X_g} = 0.372 \end{aligned}$$

$$\begin{aligned} & \text{for stability should be < 0.5} \end{aligned}$$

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$$\begin{aligned} \text{lime of pulse } \mathbf{r} & \mathbf{r} := \frac{k_{con}(\theta_0)}{G_c(\theta_0)} & \lambda := \kappa \cdot \frac{dt}{dx^2} & \lambda = 0.449 \end{aligned}$$

$$\begin{aligned} \text{for stability should be < 0.5} \end{aligned}$$

$$\begin{aligned} \text{lime of pulse } \mathbf{r} & \mathbf{r}_1 := 50 \cdot 10^{-6} \text{ sec} & x_1 := 5 \text{ mm} & Q_1(x) := \frac{AH}{\tau_1} e^{-\left(\frac{x}{x_1}\right)^2} \end{aligned}$$

$$\begin{aligned} \text{total heat} & Q_{a} := 2 \cdot A_{con} \cdot \mathbf{r}_1 \cdot \int_0^{10X_1} Q_1(x) \, dx & Q_{a} = 1.92 \times 10^{-3} \text{ joute} & Q(x, t) := i(t < \tau_1, Q_1(x), 0) \end{aligned}$$

$$\begin{aligned} \text{ntm:= 5000} \quad nxm:= 100 \quad \text{solving} & C(\theta) \cdot \frac{d\theta}{dt} = k(\theta) \cdot \frac{d^2 \cdot \theta}{dx^2} + \frac{d \cdot k(\theta)}{d\theta} \cdot \left(\frac{d\theta}{dx}\right)^2 + G(\theta) + Q(x, t) - H(\theta) \cdot \frac{P}{A} \end{aligned}$$

$$\begin{aligned} u_n(nx, n) := \begin{bmatrix} \text{for } nx \in 1 \dots nxm \\ u_{nx, 1} \leftarrow \theta_0 \\ \text{for nte 1 ...ntm} \\ u_{nx, 1} \leftarrow \theta_0 \\ \text{for nte 1 ...ntm} \\ u_{nx, 1} \leftarrow \theta_0 \\ \text{for nte 2 ...nxm} \\ u_{nx, 1} \leftarrow \theta_0 \\ \text{for nte 2 ...nxm} \\ u_{nx, 1} \leftarrow \theta_1 \\ u_{nxm, nt+1} \leftarrow u_{nx, m} t + \frac{dt}{C_{con}(u_{nx, m})} \left[ k_{con}(u_{nx, m}) \cdot \left(\frac{u_{2, m} - u_{1, mt}}{dx^2} \right) + G(u_{n, m}) + Q(dx, m d) - H_i(u_{1, m}) \cdot \frac{1}{A_{con}} \right] \end{aligned}$$

$$\begin{aligned} \mathbf{h}_{nx, 1} = \left[ \frac{h}{h} \cdot \mathbf{h}_{nx, 1} + \frac{dt}{C_{con}(u_{mx, m})} \left[ k_{con}(u_{nx, m}) \cdot \left(\frac{u_{nx+1, m} - u_{nx, m} t}{dx^2} \right) + G(u_{nx, m}) + Q(nxm, nt d) - H_i(u_{nx, m, n}) \cdot \frac{1}{A_{con}}} \right] \end{aligned}$$



 $\theta_g = 6.233K$ 

 $U_{3,2000} = 4.528$ 

 $U_{3,2500} = 4.481$ 

 $U_{3,3000} = 4.454$